

A CURRENT-TO-DIGITAL CONVERTER

Field of the Invention

This invention relates to a current-to-digital converter suitable for wide-ranging current sensing applications. In particular, the current-to-digital converter comprises a delta-sigma analogue-to-digital converter which utilizes a successive-approximation-register to control a modulation of the sensed current so that the digital conversion of the modulated sensed current by the delta-sigma analogue-to-digital converter may be done with high precision.

Summary of the Prior Art

A wide-ranging current-to-digital converter is essential in applications that required high precision wide-range current measurements such as gas sensing and bio-chemical sensing applications. In these applications, the current range that is to be sensed varies from several pico-ampere to several micro-amperes. In order to achieve this, the current-to-digital converter would need to have a wide dynamic range of about 120dB and a high linearity of more than 80dB while ensuring that its power dissipation is low.

In view of the above, those skilled in the art have proposed a few approaches. The most straightforward method proposed by those skilled in the art is to employ a low-noise trans-impedance amplifier (TIA) followed by an adapted analogue-to-digital converter (ADC) as the current-to-digital converter for such applications. However, the use of a power-hungry TIA and ADC dissipates large static power and as a result, this greatly limits the dynamic range of the current-to-digital converter.

In another approach, it is proposed that the current to be sensed be directly converted into a digital form, and this is to be done using an existing ADC operated in current mode. For example, it has been proposed that a low power voltage-controlled oscillator (VCO) based current-to-digital converter (CDC) be used. This VCO based CDC utilized a VCO-based quantizer followed by a digital differentiator to realize a 2nd order noise-shaping. However, its precision is affected by the flicker noise caused by the current-steering of the digital-to-analogue converter (DAC). Consequently, it was only able to achieve a dynamic range of only 73dB.

Another CDC architecture proposed by those skilled in the art does not utilize amplifiers and as a result, it consumes lower power. In this approach, dynamic-element-matching (DEM) is employed to suppress the mismatches in the current-steering DAC to improve its linearity. However, it was only able to achieve a dynamic range of about 88.9dB

over an input range of 200nA to 3 μ A. In yet another proposed approach, a wide dynamic range CDC which was realized using a revised asynchronous delta-sigma modulator was demonstrated to be able to achieve a dynamic range of about 160dB over an input range between 100fA and 10 μ A. However, this approach is not ideal as it requires complicated DEM controls and backend calibration, which results in much greater power consumption.

In still yet another approach, it was proposed that a fully integrated low noise CDC be realized based on current-mode continuous time delta-sigma modulators. Both transistor based and capacitor based current divisions were used to reduce the reference current noise however, due to the usage of power-hungry amplifiers in this design, several mW of power were consumed when the CDC was in operation making it unsuitable for use in energy-constrained systems. Existing delta-sigma current-to-digital converters also require on-chip current references that are larger in value than the input current that is to be sensed and these on-chip current references are usually implemented using multi-bit digital-to-analogue converters operating in current mode. The downside to this approach is that the amount of power consumed by this design dramatically increases when the large input currents are sensed.

In summary, all the proposed CDCs above are unable to achieve a dynamic range of at least 100dB with low power consumption, e.g. a power consumption of a few μ W, while maintaining a wide-range sub-pA current sensitivity at its input. For those reasons, those skilled in the art are constantly striving to come up with ways to design a low-power, high-precision current-to-digital converter that has a wide dynamic range, (>119 dB).

Summary of the Invention

The above and other problems are solved and an advance in the art is made by systems and methods provided by embodiments in accordance with the invention.

A first advantage of embodiments of a circuit and method in accordance with the invention is that the current-to-digital converter has a wide input current sensing dynamic range and low power consumption as the converter utilizes a small on-chip current reference.

A second advantage of embodiments of a circuit and method in accordance with the invention is that the current-to-digital converter is able to convert sensed current into digital signals with high precision due to the use of a successive-approximate-register conversion technique to determine the modulation ratio of the sensed current before the modulated sensed current is processed by a delta-sigma converter.

A third advantage of embodiments of a circuit and method in accordance with the invention is that due to the use of a 1-bit current digital-to-analogue converter as the feedback for the delta-sigma analogue-to-digital converter, the current-to-digital converter is able to achieve a highly linear performance.

The above advantages are provided by embodiments of a device or method in accordance with the invention operating in the following manner.

According to a first aspect of the invention, a current-to-digital converter module is disclosed, the module comprising: a modulation switch, SW_K , configured to modulate an input current, I_{IN} , to produce a scaled current, I_{INK} , wherein the switch SW_K is controlled by a modulation clock F_K ; a delta-sigma analogue-to-digital converter, $\Delta\Sigma$ ADC, comprising an integrator coupled to a hysteresis comparator that is coupled to a D-type Flip-Flop being driven by a master clock, F_S , whereby an inverting output from the D-type Flip-Flop is coupled to an inverting input of the integrator using a 1-bit feedback current digital-to-analogue converter, DAC, the $\Delta\Sigma$ ADC being configured to generate digital outputs at a non-inverting output and the inverting output of the D-type Flip-Flop based on a balanced current, I_{BAL} , received at the inverting input of the integrator, whereby the balanced current I_{BAL} comprises a summation of the scaled current I_{INK} with a reference current, I_{REF} , produced by the 1-bit feedback current DAC; a successive-approximation-register (SAR) control logic configured to generate control signals based on the non-inverting outputs from the D-type Flip-Flop, a reset clock signal and the master clock F_S ; and a clock generator module that is driven by the master clock, F_S , being configured to use the control signals from the SAR control logic to determine an optimal modulation clock F_K for controlling the switch SW_K .

In accordance with a first aspect of the invention, the modulation switch SW_K comprises: a transmission gate switch that is body biased with a reference voltage V_{CM} when the switch is at an OFF-state, wherein the reference voltage V_{CM} is used as the reference voltage at the non-inverting inputs of the integrator and hysteresis comparator of the $\Delta\Sigma$ ADC.

In accordance with a first aspect of the invention, the integrator of the $\Delta\Sigma$ ADC comprises: a two-stage integrator circuit having a first and a second stage, wherein a compensation capacitor C_C couples a low impedance node of the first stage to an output of the second stage.

In accordance with a first aspect of the invention, the hysteresis comparator of the $\Delta\Sigma$ ADC comprises: an inverter based hysteresis comparator circuit having an inverter provided

at the input of the compactor circuit, wherein a threshold voltage of the inverter is similar as threshold voltages of transistors used in the comparator circuit.

In accordance with a first aspect of the invention, the 1-bit feedback current DAC comprises: a cascaded current mirror circuit.

In accordance with a first aspect of the invention, the clock generator module comprises: a plurality of D-type Flip Flop, logic AND gate pairs and a logic OR gate, configured in a frequency divider configuration to generate a modulation pulse.

According to a second aspect of the invention, a method for converting current to digital signals using a current-to-digital converter module having a modulation switch SW_K , a delta-sigma analogue-to-digital converter, $\Delta\Sigma$ ADC, comprising an integrator coupled to a hysteresis comparator that is coupled to a D-type Flip-Flop being driven by a master clock, F_S , a successive-approximation-register (SAR) control logic, and a clock generator module that is driven by the master clock, F_S is disclosed, the method comprising: modulating, using the modulation switch, SW_K , an input current, I_{IN} , to produce a scaled current, I_{INK} , wherein the switch SW_K is controlled by a modulation clock F_K ; coupling an inverting output from the D-type Flip-Flop an inverting input of the integrator using a 1-bit feedback current digital-to-analogue converter, DAC, generating, using the $\Delta\Sigma$ ADC, digital outputs at a non-inverting output and the inverting output of the D-type Flip-Flop based on a balanced current, I_{BAL} , received at the inverting input of the integrator, whereby the balanced current I_{BAL} comprises a summation of the scaled current I_{INK} with a reference current, I_{REF} , produced by the 1-bit feedback current DAC; generating, using the SAR control logic, control signals based on the non-inverting outputs from the D-type Flip-Flop, a reset clock signal and the master clock F_S ; and determining, using a clock generator module, based on the control signals from the SAR control logic an optimal modulation clock F_K for controlling the switch SW_K .

In accordance with a second aspect of the invention, the modulation switch SW_K comprises: a transmission gate switch that is body biased with a reference voltage V_{CM} when the switch is at an OFF-state, wherein the reference voltage V_{CM} is used as the reference voltage at the non-inverting inputs of the integrator and hysteresis comparator of the $\Delta\Sigma$ ADC.

In accordance with a second aspect of the invention, the integrator of the $\Delta\Sigma$ ADC comprises: a two-stage integrator circuit having a first and a second stage, wherein a compensation capacitor C_C couples a low impedance node of the first stage to an output of the second stage.

In accordance with a second aspect of the invention, the hysteresis comparator of the $\Delta\Sigma$ ADC comprises: an inverter based hysteresis comparator circuit having an inverter provided at the input of the compactor circuit, wherein a threshold voltage of the inverter is similar as threshold voltages of transistors used in the comparator circuit.

In accordance with a second aspect of the invention, the 1-bit feedback current DAC comprises a cascaded current mirror circuit.

In accordance with a second aspect of the invention, the clock generator module comprises: a plurality of D-type Flip Flop, logic AND gate pairs and a logic OR gate, configured in a frequency divider configuration to generate a modulation pulse.

Brief Description of the Drawings

The above advantages and features in accordance with this invention are described in the following detailed description and are shown in the following drawings:

Figure 1 illustrating a system level block diagram of a current-to-digital converter in accordance with embodiments of the invention;

Figure 2a illustrating an exemplary circuit diagram of a successive-approximation-register (SAR) control logic in accordance with embodiments of the invention;

Figure 2b illustrating an exemplary circuit diagram of the modulator clock generator in accordance with embodiments of the invention;

Figure 2c illustrating timing diagrams of the modulator clock generator shown in Figure 2a in accordance with embodiments of the invention;

Figure 2d illustrating timing diagrams of the modulator clock generator shown in Figure 2a in accordance with embodiments of the invention;

Figure 2e illustrating a timing diagram of a successive-approximation register and a delta-sigma analogue-to-digital converter in accordance with embodiments of the invention;

Figure 3a illustrating a block diagram of a low leakage switch reset switch RST in accordance with embodiments of the invention;

Figure 3b illustrating a circuit diagram of a low leakage switch SW_k in accordance with embodiments of the invention;

Figure 4 illustrating a circuit diagram of an integrator in accordance with embodiments of the invention;

Figure 5 illustrating circuit diagram of a hysteresis comparator in accordance with embodiments of the invention;

Figure 6 illustrating a circuit diagram of a 1-bit digital-to-analogue converter in accordance with embodiments of the invention;

Figure 7 illustrating a plot of the dynamic range of the output of the current-to-digital converter for input current varying between 5pA to 5 μ A; and

Figure 8 illustrating a plot of the output spectrum of the current-to-digital converter when an input current of 2 μ A is sensed.

Detailed Description

This invention relates to a current-to-digital converter suitable for a wide range of current sensing applications. In particular, the current-to-digital converter comprises a delta-sigma analogue-to-digital converter ($\Delta\Sigma$ ADC), which utilizes a successive-approximation-register (SAR) control logic to generate a modulation clock using a clock generator module, whereby the modulation clock is used to control the modulation of a modulation switch SW_K . A scaled current I_{INK} is then subsequently generated by modulating the sensed input current I_{IN} . The scaled current I_{INK} is then summed with a reference current I_{REF} to produce a balanced current I_{BAL} which is then used as the input to the $\Delta\Sigma$ ADC circuit. This ensures that the digital conversion of the modulated sensed current by the $\Delta\Sigma$ ADC circuit may be done with high precision.

In accordance with an embodiment of the invention, a system level block diagram of the current-to-digital converter 100 is illustrated in Figure 1. As illustrated in Figure 1, it can be seen that converter 100 comprises a modulation switch, SW_K , delta-sigma analogue-to-digital converter ($\Delta\Sigma$ ADC) circuit 102, counter/shifter 120, successive-approximate-register (SAR) control logic 125 and clock generator module 130. In accordance with embodiments of the invention, the $\Delta\Sigma$ ADC circuit 102 comprises, but is not limited to, integrator 105 having an output that is coupled to comparator 110 which in turn has its output coupled to D-type Flip-Flop 115. A 1-bit current digital-to-analogue converter (DAC) 135 is then arranged in a feedback configuration between an inverting output of D-type Flip-Flop 115 and an inverting input of integrator 105.

In operation, it can be seen that when an input current is sensed by converter 100, the input current I_{IN} is firstly scaled by a scale factor K to produce scaled current I_{INK} . This is done using modulation switch SW_K which is in turn controlled by a modulation clock F_K whose duty cycle is determined by clock generator module 130. The scale factor K is defined as the ratio of T_p/T_k , where T_k denotes the period when the modulation switch SW_K is switched “ON”, and T_p represents the period when the modulation switch SW_K is switched “OFF”. As a result, the average current received by the input of the $\Delta\Sigma$ ADC circuit 102 of current-to-digital converter 100 is scaled down by a scale factor K . This is advantageous as it significantly reduces the on-chip reference current of current-to-digital converter 100.

The scaled current I_{INK} is then summed with a reference current I_{REF} at the input of the $\Delta\Sigma$ ADC circuit 102 to produce a balanced current I_{BAL} . The balanced current I_{BAL} will then be integrated using integrator 105 to produce an output voltage. It should be noted that integrator 105 may be controlled using a reset clock RST. In particular, for each clock cycle, the balanced current I_{BAL} will be integrated at integrating capacitor C_{INT} , which is provided between an output of integrator 105 and an inverting input of integrator 105. As a result, the output voltage from integrator 105 may be defined as V_n where n represents the n^{th} clock cycle, i.e. $n = 1, 2 \dots N$. Comparator 110 then receives the output voltage V_n from integrator 105 and compares this voltage with a reference voltage V_{CM} to produce a digital output D_n which is defined as $D_n \in \{-1, 1\}$. The output voltage V_n may then be defined as follows:

$$V_n = V_{n-1} + \left(\frac{I_{IN}}{K \cdot I_{REF}} - D_n \right) \cdot \frac{I_{REF}}{F_S \cdot C_{INT}} \quad \dots \text{Equation (1)}$$

$$D_n = \text{sign}(V_{n-1} + D_{n-1} \cdot \Delta) \quad \dots \text{Equation (2)}$$

where Δ is defined as the hysteresis level of comparator 110 and F_S is defined as the master clock of converter 100.

From the equations above, it is shown that V_n is bounded to $\left(\Delta + \frac{2 \cdot I_{REF}}{F_S \cdot C_{INT}} \right)$. After N conversion cycles have passed, a hysteresis residue will occur and this hysteresis value is defined by $\frac{(D_N - D_0) \cdot \Delta}{N}$. The value of this residue is larger than that of a conventional non-hysteresis modulator as such, in accordance with embodiments of the invention, comparator 110 may comprise a tune-able hysteresis comparator whose hysteresis range may be adjusted to produce the required resolution.

The digital output D_n is then provided to an input of D-type Flip-Flop 115. Flip-Flop 115 uses digital output D_n to generate bit streams B_n and $\bar{B}_n$ which are subsequently provided to

SAR control logic 125 and 1-bit current DAC 135 respectively. 1-bit current DAC 135 is configured to utilize the bit stream $\bar{B}_n$ to control the switching of on-chip reference current I_{REF} . By doing so, this effectively reduces the number of conversion cycles N required, especially when the input current I_{IN} is much smaller in magnitude as compared to the reference current I_{REF} . Furthermore, when the number of conversion cycles N are reduced, this greatly improves the energy efficiency of converter 100. The converter's linearity is also improved as the reduction in the switching of the 1-bit current DAC also reduces interferences caused by substrate noise.

When the bit stream B_n , master clock F_S , and reset clock RST are provided to SAR control logic 125, SAR control logic 125 will determine the scaling factor K by generating a control signal $S_0 \sim S_7$ for clock generator module 130 to determine the modulation clock F_K that is to be applied to modulation switch SW_K . Only one signal in $S_0 \sim S_7$ will be at logic '1' when the output of comparator changes from '0' to '1', and it is that signal that is used to select one of the corresponding output of $F_{K_2} \sim F_{K_256}$ to obtain F_K .

During the process of determining the scale factor K , the initial scale factor will be based on the most-significant-bit (MSB) ratio of SAR control logic 125 (i.e. $K=256$). This MSB ratio is then used by clock generator module 130 and master clock F_S to generate the modulation clock F_K . After one clock period of master clock F_S has lapsed, the input current I_{IN} would have flowed through modulation switch SW_K . The input current I_{IN} would then be continuously subtracted from the reference current I_{REF} , as generated by 1-bit current DAC 135, for the remaining cycles of master clock F_S . This in turn causes the output voltage V_n of integrator 105 to increase until the output voltage V_n exceeds an upper threshold voltage of comparator 110 causing the digital output D_n of comparator 110 to change. If no changes occur at the digital output D_n of comparator 110, the MSB ratio of SAR control logic 125 will reduce by one-significant bit, i.e. MSB-1. This is realized by the shifter register via D-type Flip Flop in SAR control logic 125 to make the MSB-1 bit as logic '1', the corresponding bit is used in clock generator module 130 together with master clock F_S to obtain new F_K . This process repeats until the digital output D_n of comparator 110 changes and when this happens, the converter would have determined the optimum modulation clock signal F_{K_OPT} that matches with the reference current I_{REF} .

In accordance with embodiments of the invention, SAR control logic 125, may comprise, but is not limited to, D-type Flip Flops, logic NOT gates, and logic AND gates as illustrated in Figure 2a. The input signal for this module are master clock F_S , reset clock RST, and the positive output B_n of module 115. The SAR logic starts from the MSB, i.e. S_7 . Unlike

conventional SAR logics, as SAR control logic 125 does not have to complete all the ratio searching cycles for various input signals in order to determine the optimum modulation clock signal for converter 100, the approach described above is more energy efficient, effective and more able to adapt to changes in the input signal. This is realized by carrying out the logic AND gate operation between the inverted B_n and all the conventional SAR logic outputs except for the MSB S_7 (see Figure 2a).

In accordance with embodiments of the invention, clock generator module 130, may comprise, but is not limited to, a frequency divider and a logic AND gate driven by master clock F_S . This ensures that the accuracy of the scaling factor K is high as compared to methods that utilize Process-Voltage-Temperature (PVT) sensitive analogue methods.

In embodiments of the invention, an exemplary circuit diagram of clock generator module 130 is illustrated in Figure 2b and may comprise of 16 D-type flip flops, 8 logic AND gates and an logic OR gate. In Figure 2b, only D-type flip flops 202, 212, 222, 232, 206, 216, 226, 236, logic AND gates 204, 214, 224, 234, and logic OR gate 208 are illustrated, i.e. a total of 4 pairs and 1 OR gate. One skilled in the art will recognize that the other 8 pairs of D-type flip flops, logic AND gates were omitted from this illustration for brevity. As illustrated, for each of D-type flip flops 202, 212, 222, 232, each D-type flip flop has its output port QN shorted to its input port D to form a frequency divider. For each of D-type flip flops 206, 216, 226, 236, each of these flip flops are configured to receive control signals S_0, S_1, S_2, S_7 from SAR control logic 125 at each of their input ports CLK, respectively.

The first D-type flip flop of module 130 is D-type flip flop 202, and this flip flop is configured to receive master clock F_S at input port CLK. Logic AND gate 204 is then configured to receive at its two input ports, master clock F_S and the output signal from output port Q of D-type flip flop 202 to produce output signal F_{K_2} . The next D-type flip flop in this chain is D-type flip flop 212, which is then subsequently configured to receive the output signal from output port Q of D-type flip flop 202 at its input port CLK. Logic AND gate 214 is then configured to receive at its two input ports, the output from logic AND gate 204 (i.e. output signal F_{K_2}) and the output signal from output port Q of D-type flip flop 212 to produce output signal F_{K_4} . Similarly, the next D-type flip flop, D-type flip flop 222 is then configured to receive the output signal from output port Q of D-type flip flop 212 at its input port CLK. Logic AND gate 224 is then configured to receive at its two input ports, the output from logic AND gate 214 (i.e. output signal F_{K_4}) and the output signal from output port Q of D-type flip flop 222 to produce output signal F_{K_8} .

A series of similarly configured “daisy-chained” D-type flip flops and logic AND gates (all not shown) are then used to generate output signals F_{K_16} , F_{K_32} , F_{K_64} , and F_{K_128} . The final D-type flip flop illustrated in this exemplary circuit is D-type flip flop 232, which is configured to receive the output signal from output port Q of a previous D-type flip flop at its input port CLK. The logic AND gate 234 is then configured to receive at its two input ports, the output from a previous logic AND gate (i.e. output signal F_{K_128}) and the output signal from output port Q of D-type flip flop 232 to produce the output signal F_{K_256} . The output signals F_{K_2} , F_{K_4} , F_{K_8} , F_{K_16} , F_{K_32} , F_{K_64} , F_{K_128} and F_{K_256} are then provided to the input port D of another 8 D-type flip flops correspondingly and control signals S_0 , S_1 , S_2 , S_3 , S_4 , S_5 , S_6 , S_7 from the SAR control logic 125 are provided to the input port CLK of these 8 D-type flip flops accordingly as illustrated in Figure 2b. Outputs from output port Q of all the eight (8) D-type flip flops are then provided to a logic OR gate to generate the final signal F_K .

In summary, the modulation clock F_K generated by clock generator module 130 may comprise output signals F_{K_2} , F_{K_4} , F_{K_8} , F_{K_16} , F_{K_32} , F_{K_64} , F_{K_128} and F_{K_256} and is controlled by control signals S_0 , S_1 , S_2 , S_3 , S_4 , S_5 , S_6 , S_7 from the SAR control logic 125. The resulting modulation clock F_K generated by the exemplary circuit in Figure 2b is plotted in Figures 2c for output signals F_{K_2} , F_{K_4} , F_{K_8} , F_{K_16} , F_{K_32} , and at Figure 2d for output signals F_{K_64} , F_{K_128} and F_{K_256} . From the plots in Figures 2c and 2d, it can be seen that the ratio between the ‘OFF’ state periods and the ‘ON’ state periods are highly accurate, and robust against PVT variations.

Once the optimal modulation clock signal has been determined, during the steady state operation of converter 100, bit streams B_n and $\bar{B}_n$ will then be provided to a counter/shifter 120. Counter/shifter 120 is provided at the output of $\Delta\Sigma$ ADC circuit 102 and is configured to act as a decimation filter to produce the digital output D_{OUT} of current-to-digital converter 100. It should be noted during the operation of converter 100, modulation switch SW_K will be in its OFF-state for most of the conversion cycles if large input currents I_{IN} are provided.

Figure 2e illustrates the timing diagram of the master clock F_S and the modulation clock F_K to determine the optimum modulation clock signal that is to be used by converter 100. The determination process comprises two steps. The first step is to determine the modulation clock via SAR control operation. It starts from the MSB (i.e. $K=256$), where the output signal for F_K is F_{K_256} at the output of module 130. If D-type flip flop 115's non-inverting output is changed, then the signal for F_K is maintained at F_{K_256} at the output of module 130 for the following conversion. Conversely, if D-type flip flop 115's non-inverting output is unchanged, then the output signal for F_K is shifted to be F_{K_128} at the output of module 130 (and this is controlled by the control signal from SAR control logic 125). These steps then continuously repeat until an

optimum modulation clock F_K is determined, i.e. F_K remains unchanged. Once the optimum modulation clock F_K has been determined, SAR control logic 125 will not continue to select the remaining one or several least-significant-bits (LSBs). The second step of the sigma-delta conversion may now commence and operate at the predetermined optimum modulation clock F_K with the master clock F_s to obtain the output bitstreams.

In operation, modulation switch SW_K and reset switch RST (at integrator 105) will be in an "OFF" state for the larger clock cycles. As a result, an appropriate low leakage switch has to be used for the design of these two switches. Such a low leakage reset switch RST is illustrated in Figure 3a and a low leakage modulation switch SW_K is illustrated in Figure 3b. With reference to the low leakage switch design illustrated in Figure 3b, it is shown that a body biased circuit 305 is used to bias the 'body' of the switch with reference voltage V_{CM} when the low leakage switch is in an "OFF" state. In this design, when the low leakage switch is in an "ON" state, the switch will operate like a conventional transmission gate switch. When the circuit is simulated based on a 40nm CMOS process, the results show that the leakage current in the circuit may be reduced by about 2 times ($\sim 2x$), from 140fA to 72fA, when the smallest transistor sizes were selected. The detailed workings of the low leakage switch is omitted for brevity as the workings of such a switch are known to those skilled in the art. It should be noted that the body bias technique utilizing the biased circuit 305 may be applied the reset switch RST too.

The circuit diagram of an integrator that may be used as integrator 105 is illustrated in Figure 4. The integrator shown in Figure 4 comprises two stages, a first-stage 405 that is coupled to a second-stage 410. To reduce the power consumption of the circuit without sacrificing bandwidth, an indirect compensation technique using a capacitor C_C is employed in this two-stage design. As illustrated in Figure 4, the compensation capacitor C_C is connected to the low impedance node of the first stage 405. This ensures that the output stage, i.e. second-stage 410 draws a comparable current as the first stage 405. Furthermore, this increase in the DC gain of the circuit helps to reduce the input referred noise. Based on this design, simulation results based on a 40nm CMOS process showed that a DC gain of >80 dB was achieved, with a gain-bandwidth product of >8 MHz when the power consumed was $14\mu W$. Additionally, in embodiments of the invention, large-sized PMOS transistors may be used as the input transistor pairs to reduce the flicker noise below the required noise floor of 100fA.

Figure 5 illustrates the circuit diagram of a modified inverter-based hysteresis comparator that may be used as comparator 110 in accordance with embodiments of the invention. When the circuit in Figure 5 is compared with conventional hysteresis comparators

which consist of preamplifier and decision stages, it was found that the circuit in Figure 5 consumed lower power and did not suffer from PVT variations. This was achieved through the use of inverter 505 which is connected to node V_{IN} (which is configured to receive an input voltage) whereby the threshold voltage of inverter 505 was set to be the same as that of the tuning circuits. The use of inverter 505 allowed the circuit to become insensitive to PVT hysteresis voltages. Additionally, transistors M_{P2A} , M_{N2A} (M_{P2B} , M_{N2B}) are biased in their triode regions using their upper or lower threshold voltages respectively V_H (V_L). In addition, the complementarity control signal will select the corresponding lower or upper sides for tuning of the threshold voltage. As such, when the input voltage becomes high or low, the core inverter will be able to operate at the various threshold voltages. When the circuit in Figure 5 was simulated based on a 40nm CMOS process, it was shown that the number of maximum variations may be maintained below 1.2 mV.

Figure 6 illustrates a circuit diagram of a 1-bit current DAC in accordance with embodiments of the invention. In this embodiment of the invention, the on-chip reference current was chosen to be 20 nA so that it would be able to handle input currents as large as 5 μ A. As shown in Figure 6, the circuit comprises a cascaded current mirror circuit which is designed to copy the reference current with high precision. In order to reduce the non-linear effects such as charge injection and clock feedthrough during the integration step, the switch transistor is connected at its source instead of at its drain. Additionally, to reduce transistor noise, the transistors are designed to have a large length L , and a simple chopping technique is employed. This was found from simulation results to reduce the noise level from 4pArms to 73fA within 5Hz.

Current-to-digital converter 100 was then simulated based on a 40nm CMOS process and it was found that the converter circuit consumed a total power of 20 μ W when the voltage supplied was 1.2V. For the simulation, the sampling frequency was set to be 1.28 MHz, and it was found that the slowest scaling frequency was 5 kHz with $K=256$ when the input current was at its maximum level. The on-chip reference current was set to be 20nA. The resulting dynamic range for input current ranging between 5pA to 5 μ A is plotted in Figure 7. It can be seen that the output is highly linear and this was achieved due to the use of the 1-bit current DAC.

The output power spectrum of the circuit is illustrated in Figure 8. For this plot, a DC input current of 2 μ A was applied and a fast-Fourier transform (FFT) was applied to the raw data to produce the plot in Figure 8. When the conversion time was 200ms, the input-referred

noise was found to be 110fA within band, and as a result the dynamic range of this design was found to be more than 164dB.

The performance of converter 100 was benchmarked against other current-to-digital converters known in the art and the comparative benchmarks are plotted below in Table 1. From the results plotted in Table 1, it can be seen that the digital-intensive designs in Prior Art 1 and 2 were able to achieve low power consumption levels, however, their resolutions were limited due to the flicker noise and mismatches in the DAC respectively. Although the converter in Prior Art 3 was able to cover a wider range, it requires calibration and complicated digital correction. As for the converter in Prior Art 4, as it employs multi-current references to cover the current range, the resolution in a fixed-range is just 78.2 dB. The converter in Prior Art 5 utilizes a current mode continuous-time $\Delta\Sigma$ modulator and as a result, extensively larger power is consumed to suppress the noise floor. Among all the current-to-digital converters in the prior art, only converter 100 was able to achieve a sensing range of several pA to μ A within tens of microwatt power.

Parameters	Prior Art 1	Prior Art 2	Prior Art 3	Prior Art 4	Prior Art 5	This work
Architecture	$\Delta\Sigma$	IR- $\Delta\Sigma$	Nonlinear $\Delta\Sigma$	$\Delta\Sigma$	VCO- $\Delta\Sigma$	SAR- $\Delta\Sigma$
Process (μ m)	0.35	0.18	0.18	0.35	0.18	0.64
Supply Voltage (V)	± 1.5	1.8	1.8	1.5	51.8	1.2
Power (μ W)	6750	50.3	295	16.8	80	22
Sensing range (A)	1n	1.1p	0.1p to 10p	200n to 3p	1n to 4p	5p to 5p
On-chip I _{ref} (μ A)	0.001	1	10	3.2	4	0.02
Resolution (LSB)	290	123	100	100000	1000000	110
Fixed-scale DR (dB)	60	78.2	104	88.9	73	119
Cross-scale DR (dB)	N.A.	139	180	N.A.	73	>164
INL(μ A)	N.A.	N.A.	70	100	600	30
Conv. time for I _{ref} (ms)	0.1	100	400	4	400	200
Calibration	No	No	Yes	No	No	No

Table 1

The above is a description of embodiments of a circuit and method in accordance with the present invention as set forth in the following claims. It is envisioned that others may and will design alternatives that fall within the scope of the following claims.

CLAIMS:

1. A current-to-digital converter module comprising:
 - a modulation switch, SW_K , configured to modulate an input current, I_{IN} , to produce a scaled current, I_{INK} , wherein the switch SW_K is controlled by a modulation clock F_K ;
 - a delta-sigma analogue-to-digital converter, $\Delta\Sigma$ ADC, comprising an integrator coupled to a hysteresis comparator that is coupled to a D-type Flip-Flop being driven by a master clock, F_S , whereby an inverting output from the D-type Flip-Flop is coupled to an inverting input of the integrator using a 1-bit feedback current digital-to-analogue converter, DAC, the $\Delta\Sigma$ ADC being configured to generate digital outputs at a non-inverting output and the inverting output of the D-type Flip-Flop based on a balanced current, I_{BAL} , received at the inverting input of the integrator, whereby the balanced current I_{BAL} comprises a summation of the scaled current I_{INK} with a reference current, I_{REF} , produced by the 1-bit feedback current DAC;
 - a successive-approximation-register (SAR) control logic configured to generate control signals based on the non-inverting output from the D-type Flip-Flop, a reset clock signal and the master clock F_S ; and
 - a clock generator module that is driven by the master clock, F_S , being configured to use the control signals from the SAR control logic to determine an optimal modulation clock F_K for controlling the switch SW_K .
2. The module according to claim 1 wherein the modulation switch SW_K comprises:
 - a transmission gate switch that is body biased with a reference voltage V_{CM} when the switch is at an OFF-state, wherein the reference voltage V_{CM} is used as the reference voltage at a non-inverting input of the integrator and an inverting input of the hysteresis comparator of the $\Delta\Sigma$ ADC.
3. The module according to claim 1 wherein the integrator of the $\Delta\Sigma$ ADC comprises:
 - a two-stage integrator circuit having a first and a second stage, wherein a compensation capacitor C_C couples a low impedance node of the first stage to an output of the second stage.
4. The module according to claim 1 wherein the hysteresis comparator of the $\Delta\Sigma$ ADC comprises:

an inverter based hysteresis comparator circuit having an inverter provided at an input of the comparator circuit, wherein a threshold voltage of the inverter is similar as threshold voltages of transistors used in the comparator circuit.

5. The module according to claim 1 wherein the 1-bit feedback current DAC comprises:
a cascaded current mirror circuit.
6. The module according to claim 1 wherein the clock generator module comprises:
a plurality of D-type Flip Flop, logic AND gate pairs and a logic OR gate, configured in a frequency divider configuration to generate a modulation pulse.
7. A method for converting current to digital signals using a current-to-digital converter module having a modulation switch SW_K , a delta-sigma analogue-to-digital converter, $\Delta\Sigma$ ADC, comprising an integrator coupled to a hysteresis comparator that is coupled to a D-type Flip-Flop being driven by a master clock, F_S , a successive-approximation-register (SAR) control logic, and a clock generator module that is driven by the master clock, F_S , the method comprising:
 - modulating, using the modulation switch, SW_K , an input current, I_{IN} , to produce a scaled current, I_{INK} , wherein the switch SW_K is controlled by a modulation clock F_K ;
 - coupling an inverting output from the D-type Flip-Flop an inverting input of the integrator using a 1-bit feedback current digital-to-analogue converter, DAC,
 - generating, using the $\Delta\Sigma$ ADC, digital outputs at a non-inverting output and the inverting output of the D-type Flip-Flop based on a balanced current, I_{BAL} , received at the inverting input of the integrator, whereby the balanced current I_{BAL} comprises a summation of the scaled current I_{INK} with a reference current, I_{REF} , produced by the 1-bit feedback current DAC;
 - generating, using the SAR control logic, control signals based on the non-inverting output from the D-type Flip-Flop, a reset clock signal and the master clock F_S ; and
 - determining, using a clock generator module, based on the control signals from the SAR control logic an optimal modulation clock F_K for controlling the switch SW_K .
8. The method according to claim 7 wherein the modulation switch SW_K comprises:
a transmission gate switch that is body biased with a reference voltage V_{CM} when the switch is at an OFF-state, wherein the reference voltage V_{CM} is used as the reference voltage at a non-inverting input of the integrator and an inverting input of the hysteresis comparator of the $\Delta\Sigma$ ADC.

9. The method according to claim 7 wherein the integrator of the $\Delta\Sigma$ ADC comprises:
a two-stage integrator circuit having a first and a second stage, wherein a compensation capacitor C_C couples a low impedance node of the first stage to an output of the second stage.
10. The method according to claim 7 wherein the hysteresis comparator of the $\Delta\Sigma$ ADC comprises:
an inverter based hysteresis comparator circuit having an inverter provided at an input of the comparator circuit, wherein a threshold voltage of the inverter is similar as threshold voltages of transistors used in the comparator circuit.
11. The method according to claim 7 wherein the 1-bit feedback current DAC comprises a cascaded current mirror circuit.
12. The method according to claim 7 wherein the clock generator module comprises:
a plurality of D-type Flip Flop, logic AND gate pairs and a logic OR gate, configured in a frequency divider configuration to generate a modulation pulse.